Table of Contents: Vin requirements / Full load details: page 1 Full load thermal image: 8Vin steady state page 2 Full load thermal image: 28Vin steady state page 3 Full load thermal image: 6Vin, a few seconds page 4 Major waveforms of Vin to 3.3V @ full loading pages 5-6 3.3V output ripple @ full loading page 7 Core 1.06V: main waveform page 7 Core 1.06V: output ripple 500MHz BW & 20 MHz BW page 8 1.2V main waveform & output ripple page 9 5V CAN major waveform & output ripple page 10 3.3V converter efficiency & losses page 11 1.06V Bode plot & details of step load / load dump pages 12-13 1.06V step load & load dump responses pages 14-15 Sequencing: power up pages 16-17 Sequencing power down page 18 1.2V load dynamics page 19 3.3V load dynamics page 20

Test Requirements: Steady operating 8 to 18V. 18 to 26V for 2 minutes. 26 to 40 (60) V for 500ms max. No operation, just survival without damage. 6 to 8V for max 2sec.

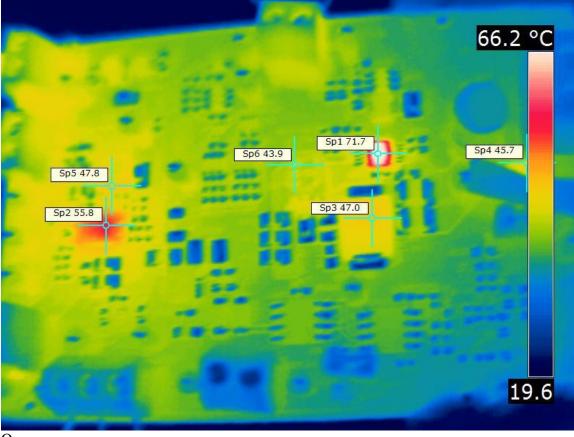
Loading:

1.06V core: 2.5A approximated with 5x 80mOhms plus 1x 20mOhm or 420mOhms in all 5V can: 100mA with 2x 100 ohms in parallel
1.2V memory: 260mA approximated with 4.7 ohm single resistor
1.8V I/O: 140mA with 3.9+3.9+3.9+1.0 string
3.3V Vdd_shv: 90mA with 3x 110 ohms in parallel (36.7 ohms)
1.8V analog: 60mA with 20//20 plus 20 for 30 ohms in all

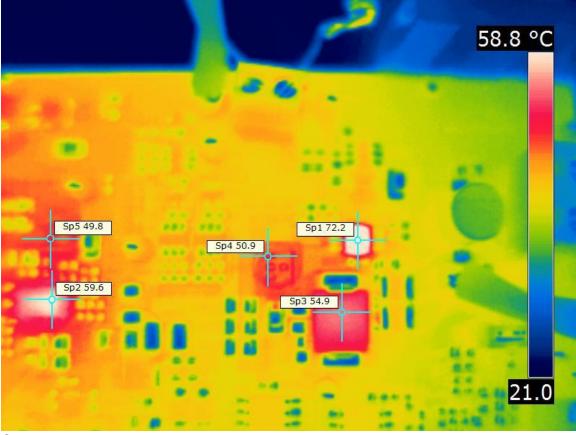
U600 and U610 for future use and will require higher current capability from the main 3.3V converter (U100). From thermal images on next 3 pages with ~ 50 degrees C rise on part vs. ambient in steady state, further loading cannot be advised.

Main 3.3V at 340kHz: 2.647W+522mW+304mW+657mW

1.0588V actual; 5.110V actual; 1.1944V actual ; 1.78935 actual; 3.319V actual; 1.7869 actual; main 3.3V at 3.323V with no other loading; 7.986Vin after diode 0.7785 Ain IR756 with 72 max on TPS54240 8Vin PMP10411 all loads room 21-23 ambient U100 at 72, U400 at 56, D100 at 47, D90 at 46 L400 at 48, L100 at 44



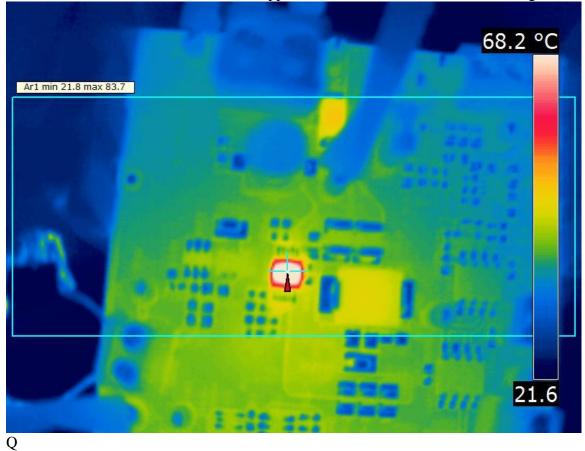
Now 28.08Vin doo3&4 for MW 0.2320ain 1.0587V actual; 5.110V actual; 1.1941V actual ; 1.7894 actual; 3.320V actual; 1.7869 actual; main 3.3V at 3.324V with no other loading; IR757 at 72 degrees C 28Vin PMP10411 all loads room 21-23 ambient U100 at 72, U400 at 60, D100 at 55 L400 at 50, L100 at 51



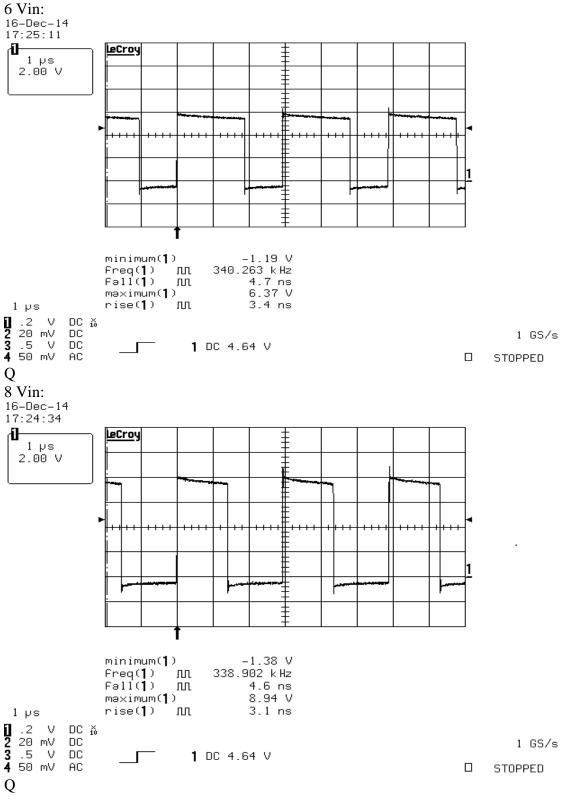
Q 28.2Vin all loads full D009 is main waveform at 42Vin D010-012 ripple on 1.06V at C406 D014 is 3.3V ripple D015 is 5V ripple D016 is 1.2V ripple D017 is MW for the 1.06V D018 is main waveform U200 for 5V D020 is mw for 1.2V D006 mw at 8Vin; doo7 at 6Vin

6.00vin 1.0422Ain: about 10 degrees rise IR760 about 3-4 seconds after Vin dropped to 6V

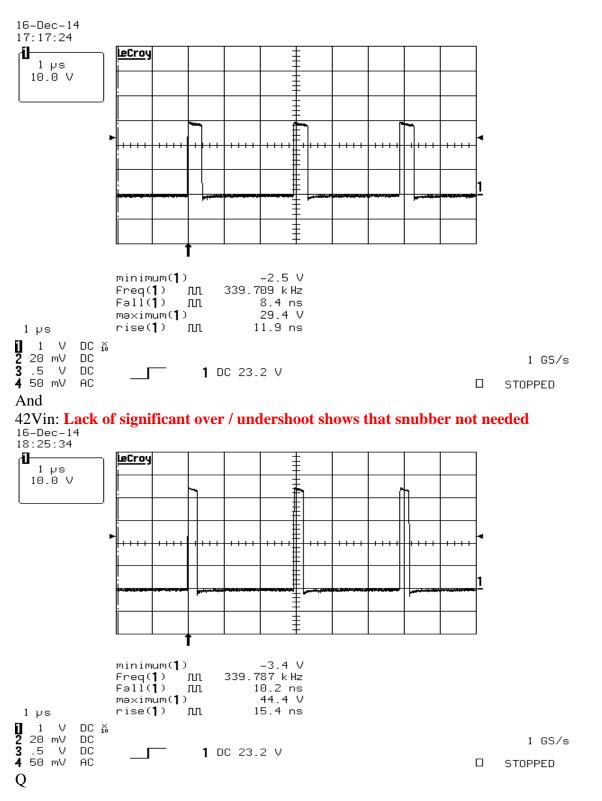
PMP10411 several seconds after Vin dropped from 8V to 6V main U100 at 84 degrees C



Major waveforms: TPS54240 U100 PH pin for 3.3V with all output loaded as on page 1: Current off 3.3V about 1.6 - 1.7 A: 500 MHz scope / 10x probe

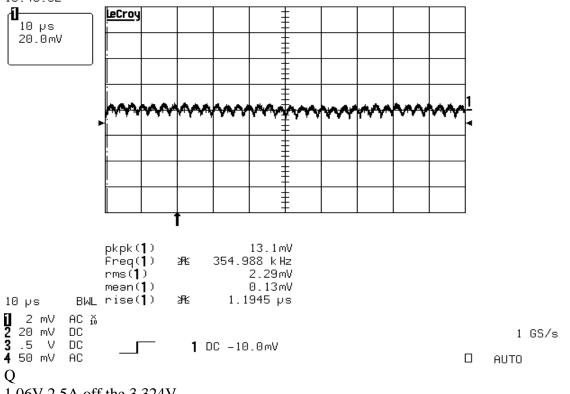


TPS54240 U100 PH pin for 3.3V with all output loaded as on page 1: Current off 3.3V about 1.6 - 1.7 A: 500 MHz scope / 10x probe (continued) 28Vin:



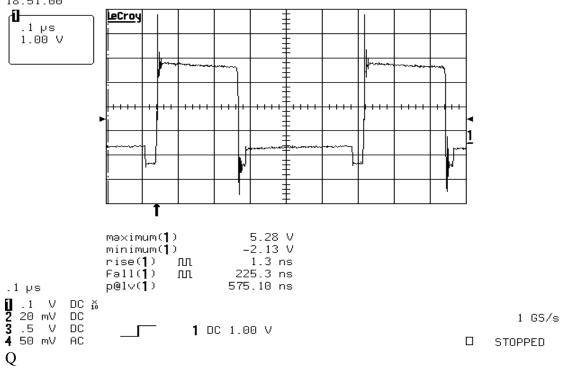
for TDA3x power off auto battery test

Ripple on 3.3V output with all outputs loaded (1.6 - 1.7A off 3.3V)16-Dec-14 18:40:32



1.06V 2.5A off the 3.324V

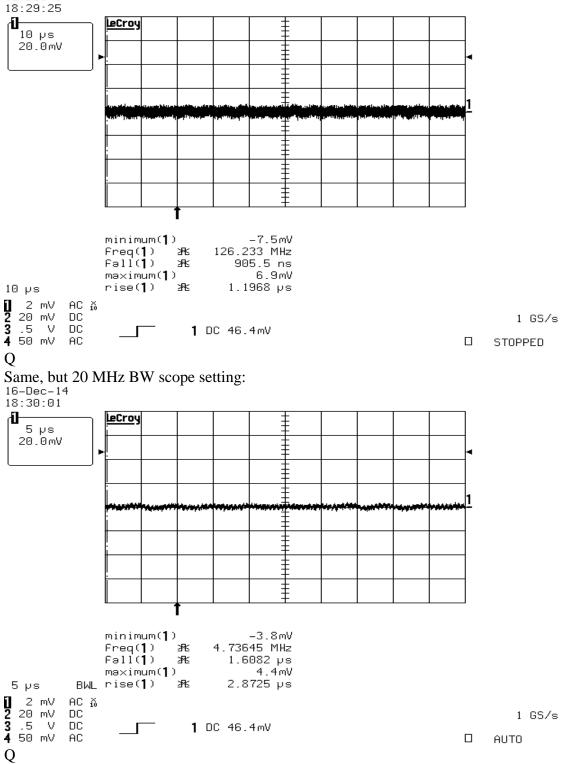
Main waveform: 500 MHz BW scope / 10x probe: period points to 1.74 MHz operation 16-Dec-14 18:51:00



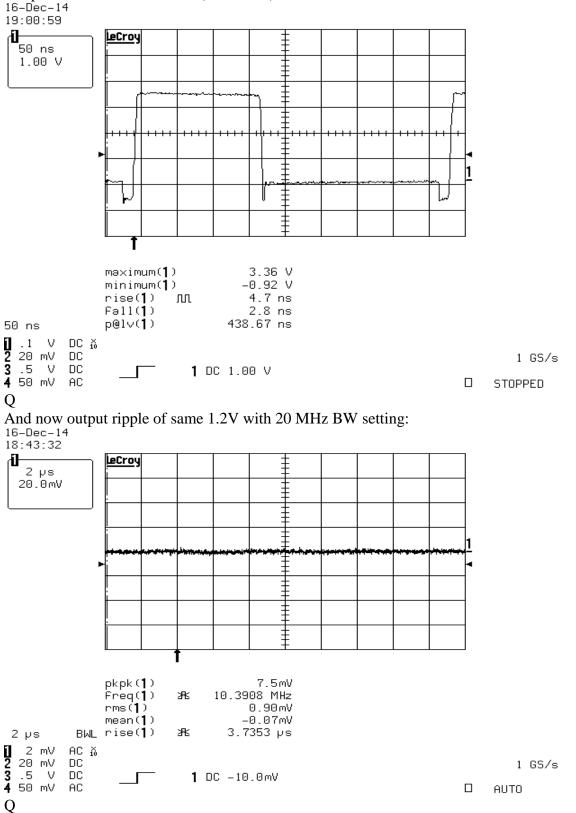
Test Report TIDA-00346 (PMP10411)

for TDA3x power off auto battery test

And now ripple out at the 1.06V with 500 MHz BW scope setting 16-Dec-14

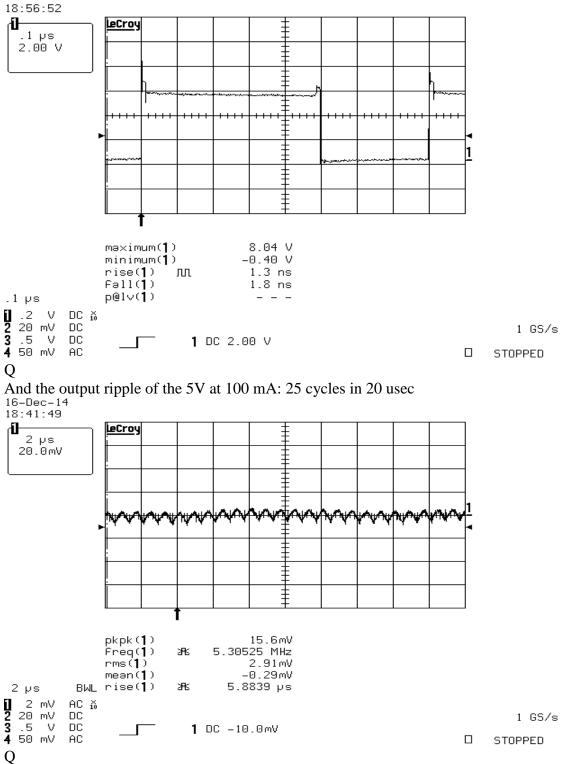


1.2V 260mA off 3.3V: Main waveform with 500 MHz BW scope / probe: one period of 439 nsec shown (2.28 MHz)



5V 100mA off 3.3V with TPS61071:

Main waveform with 500 MHz scope / probe: one 800 nsec cycle shown for 1.25 MHz

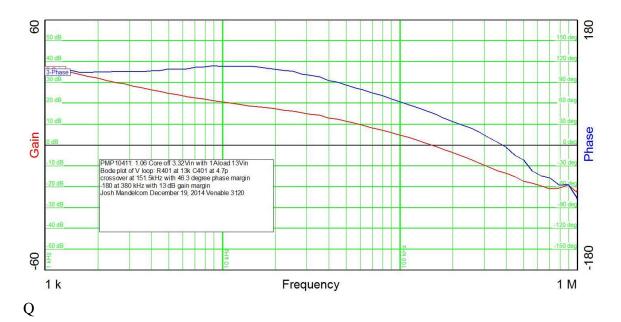


Efficiency and Losses: model t1: Only 3.3V loaded and Vin measured after D90:						
Vin	Iin A	Vout	Iout	% Effi	Losses in W	Power out of the 3.3V
Volts		Volts	А	ciency		in Watts
5.016	1.2583	3.325	1.5687	82.6	1.096	5.22
6.000	1.0377	3.3245	1.5686	83.8	1.011	5.21
7.981	0.7792	3.324	1.5686	83.8	1.005	5.21
13.011	0.4838	3.324	1.5688	82.8	1.080	5.21
18.011	0.3533	3.324	1.5687	81.9	1.149	5.21
28.09	0.2320	3.325	1.5684	80.0	1.302	5.21
42.05	0.1610	3.325	1.5687	77.0	1.554	5.22
5.023	0.9330	3.325	1.2058	85.6	0.677	4.01
6.003	0.7802	3.325	1.2053	85.6	0.676	4.01
7.985	0.5910	3.324	1.205	84.9	0.714	4.01
13.04	0.3686	3.325	1.2045	83.3	0.802	4.00
18.03	0.2705	3.325	1.2045	82.1	0.872	4.00
28.04	0.17845	3.325	1.2032	80.0	1.003	4.00
42.05	0.1240	3.326	1.204	76.8	1.210	4.00
4.988	0.6148	3.326	0.8015	86.9	0.401	2.67
6.000	0.5144	3.325	0.8012	86.3	0.422	2.66
8.00	0.3917	3.325	0.8012	85.0	0.470	2.66
13.00	0.2474	3.325	0.8007	82.8	0.554	2.66
18.02	0.1820	3.325	0.8006	81.2	0.618	2.66
28.06	0.1207	3.326	0.8005	78.6	0.724	2.66
42.05	0.08435	3.326	0.8005	75.1	0.884	2.66
4.992	0.3152	3.3255	0.4028	85.1	0.234	1.34
6.003	0.26565	3.3255	0.4024	83.9	0.257	1.34
7.992	0.2044	3.325	0.4024	81.9	0.296	1.34
13.02	0.1306	3.326	0.4022	78.7	0.363	1.34
18.02	0.0970	3.326	0.4020	76.5	0.411	1.34
28.03	0.06546	3.326	0.4017	72.8	0.499	1.34
42.0	0.0465	3.326	0.4017	68.4	0.617	1.34
4.995	0.028	3.326	0	0.0	0.140	0.00
5.976	0.0243	3.326	0	0.0	0.145	0.00
7.985	0.0195	3.326	0	0.0	0.156	0.00
13.02	0.0131	3.326	0	0.0	0.171	0.00
18.03	0.0107	3.326	0	0.0	0.193	0.00
28.08	0.0081	3.326	0	0.0	0.227	0.00
42.01	0.0062	3.326	0	0.0	0.260	0.00
0			-	0.0	0.200	

Efficiency and Losses: model t1: Only 3.3V loaded and Vin measured after D90:

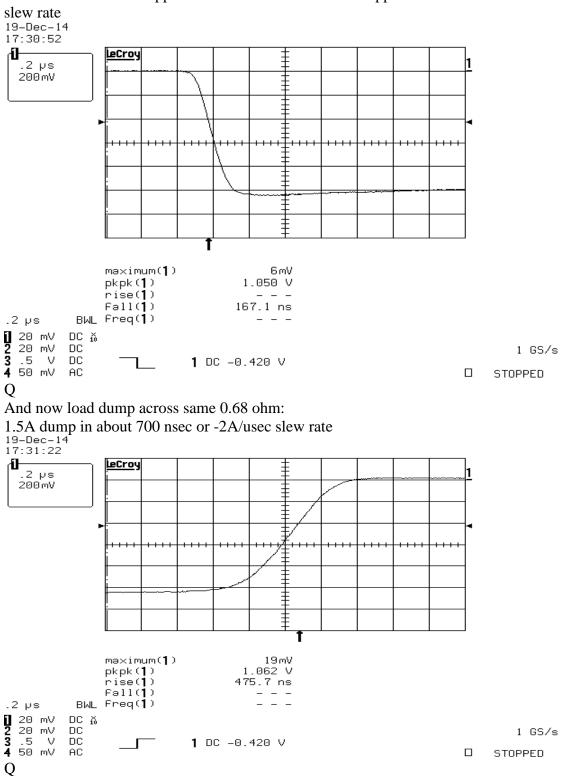
Q

Bode Plot of main 1.06V 2.5A for core:

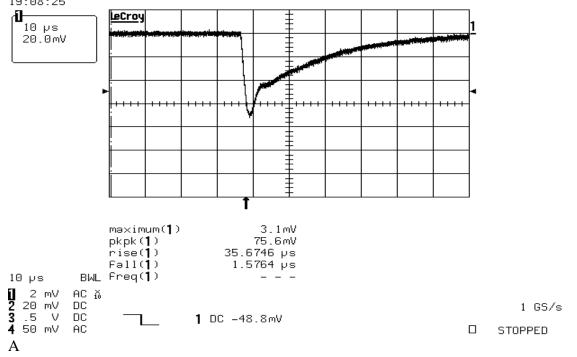


Load dynamics on the 1.06V core:

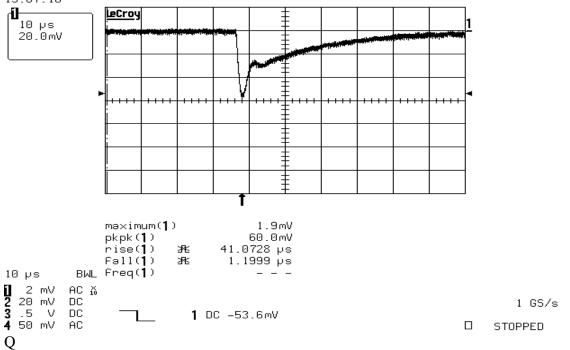
Waveform across 0.68 ohms dynamic load resistor when load applied with scope ground on Vout side of it: 1V applied in about 250 nsec or 1.5A applied in 250 nsec for 6A/usec



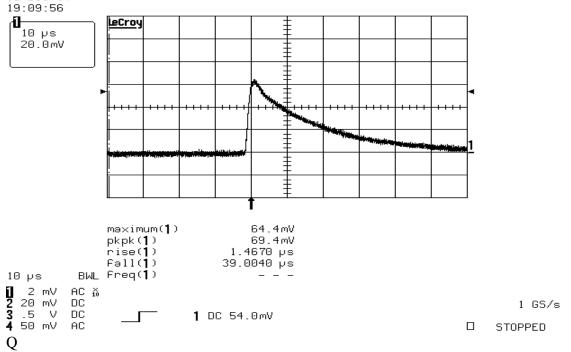
Load dynamics on the 1.06V core: Actual step load response at core Vout: Step Load response to this 1.5A in 250 nsec from zero load starting: 70 mV undershoot ^{19-Dec-14} ^{19:08:25}



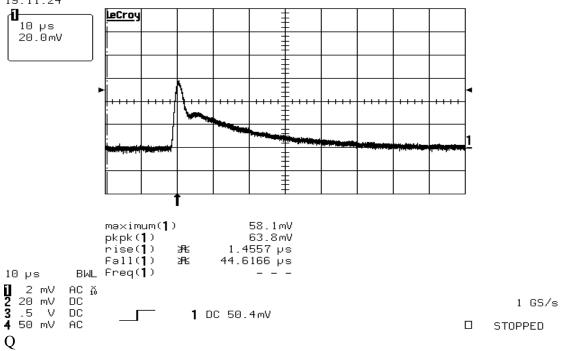
And now same step load, but with 1.0A load already on 1.06 Vcore: ~55 mV undershoot 19-Dec-14 19:07:16



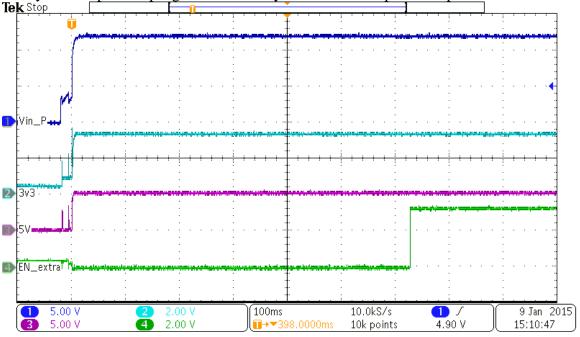
Load dynamics on the 1.06V core: Actual load dump response at core Vout: Load dump response from 1.5A going to zero load in 700 nsec: 65 mV overshoot



Load dump response from 2.5A going to 1.0A load in 700 nsec: 55 mV overshoot $\frac{19-Dec-14}{19:11:24}$

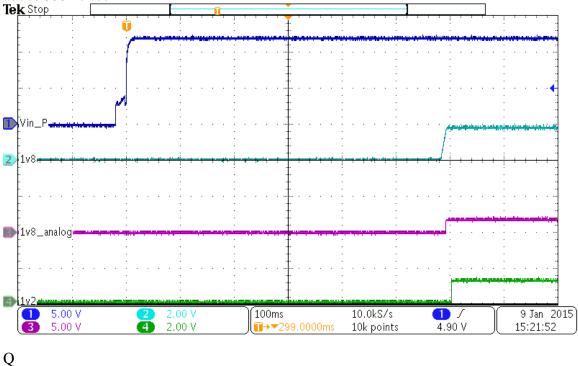


Sequencing: First showing 12Vin applied and "always on" 3.3V & 5V coing up, and finally the last power up signal to inform system that all outputs are up called EN_extra:



Q

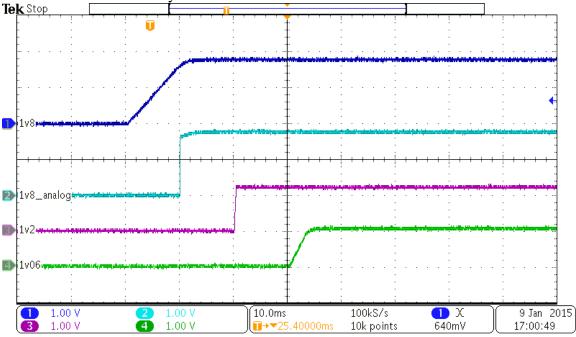
Now showing Vin and first 3 of the sequenced outputs upon power up, overall delay of about 600ms seen



~ . .

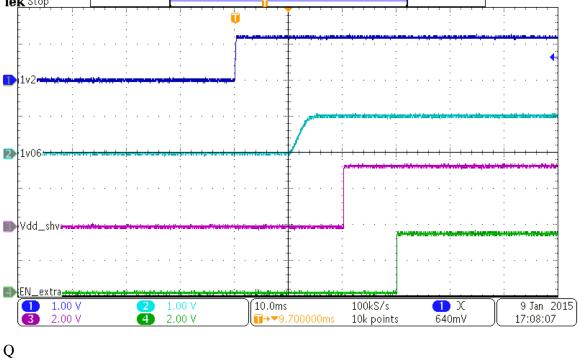
Sequencing – power up continued:

Now showing detailed sequencing of the first 4 sequenced signals at 10 ms per division to show their relative delays:



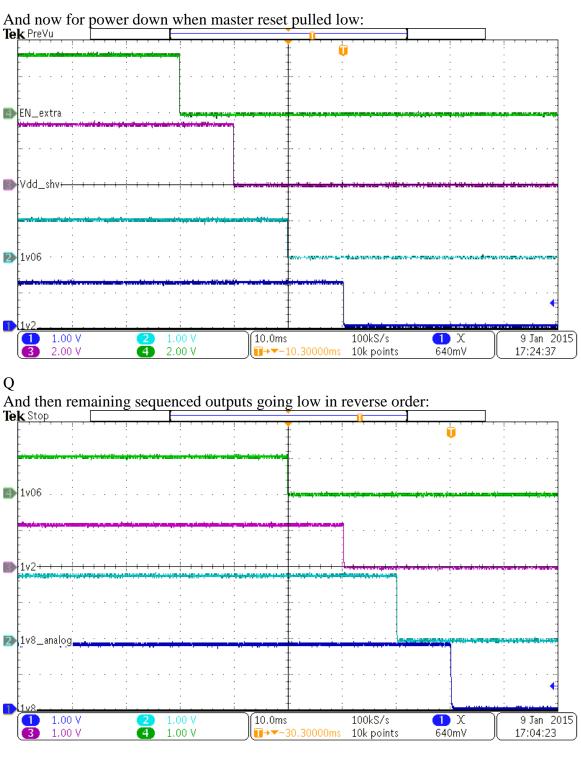
Q

Now showing 3rd, 4th, 5th sequenced outputs, and final "EN_extra" signal to system

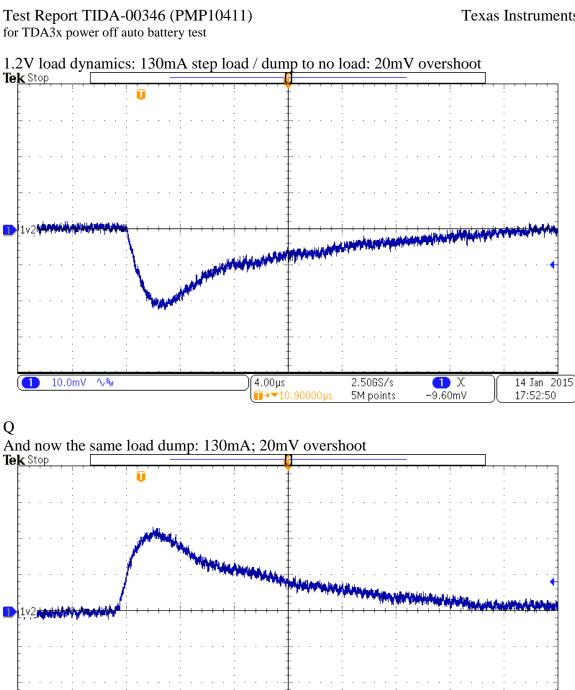


Test Report TIDA-00346 (PMP10411)

for TDA3x power off auto battery test



Q



Q Less than 2% over / undershoot well within 5% generally allowed for Memory.

■→▼10.90000µs

4.00µs

2.50GS/s

5M points

🚺 X

8.40mV

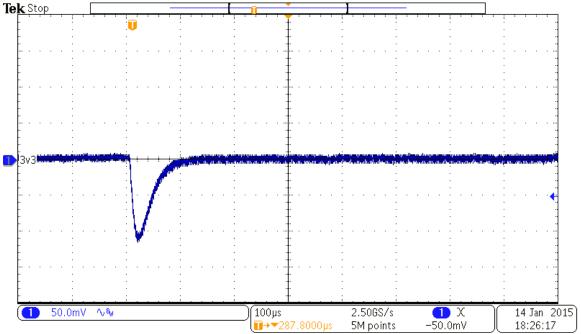
10.0mV ∿∿

1

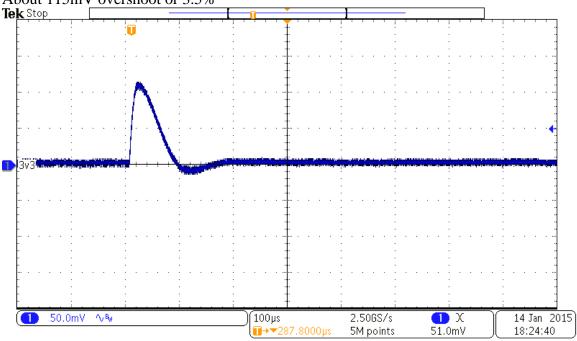
14 Jan 2015

17:53:47

3.3V 1.0 A step load & dump to about 90mA static load off the 3.3V with 12Vin: ${\sim}110mV$ undershoot



q And now same 1.0A load dump to 90mA static load About 115mV overshoot or 3.5%



Target is max deviation of +/-5% including dynamics. Passed:

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